Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

06/02/2022 Created on:

Details for "LMC6494BEMX/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LMC6494BEMX/NOPB	SN	Level-1-260C-UNLIM	Texas Instruments Electronics	D 14	8.7 x 3.9 x 1.75	152.8

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS		REACH	Green	IEC 62474 DB	
	Yes	Yes	Yes	Yes	

Component Information

	·	·		Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.062146	99.998391	999984	0.04068	41
Precious Metals	Silver	7440-22-4	0.000001	0.001609	16	0.000001	
Sub-Total			0.062147	100	1000000	0.040681	4
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.380722	75.000049	750000	0.249217	24
Thermoplastics	Epoxy	85954-11-6	0.126907	24.999951	250000	0.083072	
Sub-Total			0.507629	100	1000000	0.332289	33
Die Attach Adhesive 2							
Precious Metals	Silver	7440-22-4	0.380722	75.000049	750000	0.249217	24
Thermoplastics	Epoxy	85954-11-6	0.126907	24.999951	250000	0.083072	8
Sub-Total			0.507629	100	1000000	0.332289	33
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	41.60034	96.7	967000	27.231208	2723
Copper and Its Alloys	Iron	7439-89-6	1.023876	2.38	23800	0.67022	6
Copper and Its Alloys	Phosphorus	7723-14-0	0.012906	0.03	300	0.008448	
Precious Metals	Silver	7440-22-4	0.331254	0.77	7700	0.216836	21
Zinc and Its Alloys	Zinc	7440-66-6	0.051624	0.12	1200	0.033793	(1)
Sub-Total			43.02	100	1000000	28.160505	2816
Lead Frame Plating							
Other Nonferrous Metals and Alloys	Tin	7440-31-5	3.01	100	1000000	1.970319	197
Sub-Total			3.01	100	1000000	1.970319	197
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	89.150057	89	890000	58.356826	5835
Other Nonferrous Metals and Alloys	Metal Hydroxide	Trade Secret	3.005058	3	30000	1.967084	196
Thermoplastics	Epoxy	85954-11-6	8.013488	8	80000	5.245557	524
Sub-Total			100.168603	100	1000000	65.569467	6556
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	2.745569	100	1000000	1.797225	179
Sub-Total			2.745569	100	1000000	1.797225	179
Semiconductor Device 2							
Ceramics / Glass	Doped Silicon	7440-21-3	2.745569	100	1000000	1.797225	179
Sub-Total			2.745569	100	1000000	1.797225	179
Total			152.767146			100	10000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one Ti part number. This is due to two or more users (EMSis or subcontractors) using the same CPN for different Ti part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "ROHS Exempt" fully meets the latest EU ROHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/02/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures. TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free," These TI semiconductor products are also fully int with GADSL and the IEC 62474 database for electronic require

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet J5709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Bervllium Oxide (BeO) is <=1000ppm.